

MP1540 1.3MHz, 18V **Step-Up Converter**

The Future of Analog IC Technology

DESCRIPTION

The MP1540 is a 5-pin thin TSOT23 current mode step-up converter intended for small, low power applications. The MP1540 switches a t 1.3MHz and allows the use of tiny, low cost capacitors and inductors 2mm or less in height. Internal soft-start results in small inr ush current and extends battery life. The MP1540 operates from an input voltage a s low as 2.5V and can generate 1 2V at up t o 200mA f rom a 5 V supply.

The MP1540 include s under voltage lockout, current limiting, an d thermal overload protection to prevent damage in the event of an output overload. The MP1540 is available in a small 5-pin TSOT23 package.

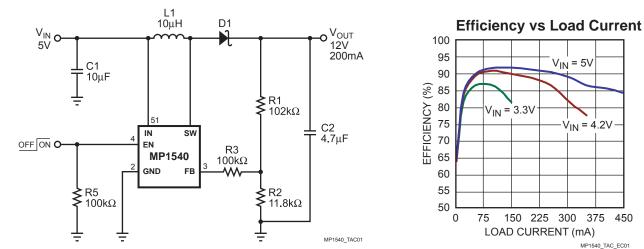
FEATURES

- On Board Power MOSFET
- Uses Tiny Capacitors and Inductors
- 1.3MHz Fixed Switching Frequency •
- Internal Soft-Start
- Operates with Input Voltage as Low as • 2.5V and Output Voltage as High as 18V
- 12V at 200mA from 5V Input
- UVLO. Thermal Shutdown
- Internal Current Limit •
- Available in a TSOT23-5 Package

APPLICATIONS

- Camera Phone Flash
- Handheld Computers and PDAs •
- **Digital Still and Video Cameras** •
- Ex ternal Modems
- Small LCD Displays
- LED Driver White

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TYPICAL APPLICATION

MP1540 Rev. 1.0 8/15/2005

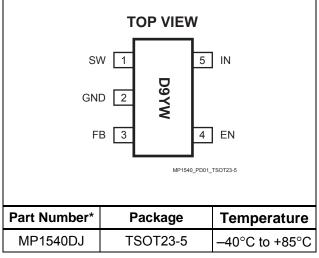
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375

450



PACKAGE REFERENCE



* For Tape & Reel, add suffix –Z (eg. MP1540DJ–Z) For Lead Free, add suffix –LF (eg. MP1540DJ–LF–Z)

ELECTRICAL CHARACTERISTICS

 $V_{IN} = V_{EN} = 5V$, $T_A = +25^{\circ}C$ unless specified otherwise

ABSOLUTE MAXIMUM RATINGS ⁽¹⁾

SW Pin	. –0.3V to +20V
All Other Pins	–0.3V to +6.5V
Junction Temperature	150°C
Lead Temperature	260°C
Storage Temperature	. 65°C to 150°C

Recommended Operating Conditions (2)

Supply Voltage V _{IN}	2.5V to 6V
Output Voltage Vout	3V to 18V
Operating Temperature	–40°C to +85°C

Thermal Resistance $^{(3)}$ θ_{JA}

TSOT23-5..... 220.....110 ...°C/W

 θ_{JC}

Notes:

1) Exceeding these ratings may damage the device.

- 2) The device is not guaranteed to function outside of its operating conditions.
- 3) Measured on approximately 1" square of 1 oz copper.

Parameters Sy	mbol	Condition	Min	Тур	Max	Units
Operating Input Voltage	V _{IN}		2.5		6	V
Under Voltage Lockout				2.25	2.45	V
Under Voltage Lockout Hysteresis				92		mV
Supply Current (Shutdown)		V _{EN} = 0V		0.1	1	μA
Supply Current (Quiescent)		V _{FB} = 1.3V		635	850	μA
Switching Frequency	f _{SW}		1.0	1.3	1.6	MHz
Maximum Duty Cycle		V _{FB} = 0V	80	85		%
EN Threshold		V _{EN} Rising	1.0	1.3	1.6	V
EN Threshold		V_{EN} Rising, V_{IN} = 2.5V		1.1		V
EN Hysteresis			100	100		mV
EN Input Bias Current		V _{EN} = 0V, 6V			1	μA
FB Voltage	V _{FB}		1.21	1.25	1.29	V
FB Input Bias Current		V _{FB} = 1.25V	-100	-30	nA	
SW On-Resistance ⁽⁴⁾ R	DS (ON)		0.65	0.65		Ω
SW Current Limit ⁽⁴⁾				1.9		Α
SW Leakage		V _{SW} = 15V			1	μA
Thermal Shutdown ⁽⁴⁾			160			°C

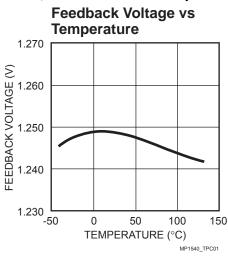
Note:

4) Guaranteed by design.

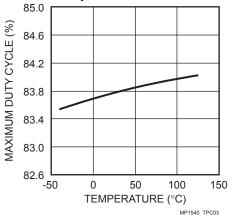


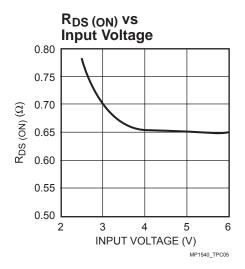
TYPICAL PERFORMANCE CHARACTERISTICS

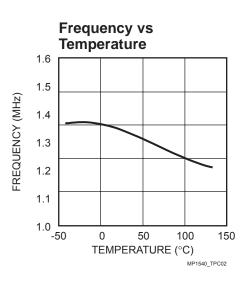
 $V_{IN} = V_{EN} = 5V$, $T_A = +25^{\circ}C$ unless specified otherwise.



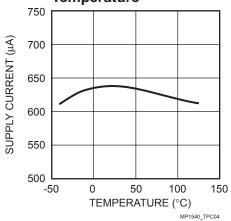


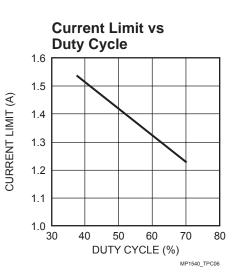






Supply Current vs Temperature





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Pin #	Name	Pin Function	
1 SW		Power Switch Output. SW is the drain of the internal MOSFET switch. Connect the power inductor and output rectifier to SW. SW can swing between GND and 20V.	
2	GND	Ground.	
3	FB	Feedback Input. FB voltage is 1.25V. Connect a resistor divider to FB.	
4 EN		Regulator On/Off Control Input. A high input at EN turns on the converter, and a low input turns it off. When not used, connect EN to the input source for automatic startup. The EN pin cannot be left floating.	
5	IN	Input Supply Pin. Must be locally bypassed.	

PIN FUNCTIONS

OPERATION

The MP15 40 use s a f ixed frequ ency, p eak current mo de boost re gulator ar chitecture to regulate vo Itage at the fee dback pin . The operation of the MP1540 can be understood by referring to the block diagram of Figure 1.

At the start of each oscillator cycle the MOSFET is tu rned on through t he con trol circuitry. To prevent sub-harmonic oscillations at duty cycles greater than 50 pe rcent, a stab ilizing ra mp is added to t he out put of the current sense amplifier and the result is fed into the negative input of the PWM comparator. When this voltage equals the output voltage of th e error amplifier the power MOSFET is turned off. The voltage at the output of the error amplifier is an amplified version of t he difference between the 1.25V bandgap reference voltage and the feedback voltage. In this way the peak current level ke eps the out put in reg ulation. I f the feedback voltage starts to drop, the output of the error amplifier increases. This re sults in more current to flow through the power MOSFET, thus increasing the power delivered to the output.

The MP1540 has intern al soft start to limit the amount of input current at startup and to also limit the amount of overshoot on t he output. The current limit is increased by a fourth every $40\mu s$ giving a total soft start time of $120\mu s$.

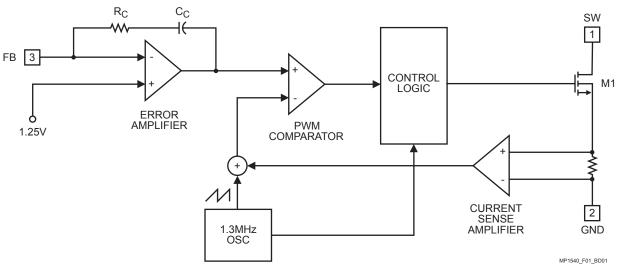


Figure 1—Functional Block Diagram

APPLICATIONS INFORMATION

COMPONENT SELECTION

Setting the Output Voltage

Set the output voltage by selecting the resistive voltage divider ratio. Use $11.8k \Omega$ f or the lo w-side resist or R2 of the voltage divider. Determine the high-side resist or R1 by the equation:

$$R1 = \frac{R2(V_{OUT} - V_{FB})}{V_{FB}}$$

Where V_{OUT} is the output voltage and V_{FB} is the feedback voltage.

For R2 = $11.8k\Omega$ and V_{FB} = 1.25V, then

R1 ($k\Omega$) = 9.44 $k\Omega$ ($V_{OUT} - 1.25V$).

Selecting the Input Capacitor

An input ca pacitor is required to supply the AC ripple current to the inductor, while limiting noise at the input source. This capacitor must have low ESR, so ceramic is the best choice.

Use an in put capacit or value of 4.7 μ F or greater. This capacit or must be placed physically close to the I N pin. Since it reduces the voltage ripple seen at IN, it also reduces the amount of EMI passed back alo ng that line to the other circuitry.

Selecting the Output Capacitor

A single 4 $.7\mu$ F to 10 μ F ceramic capacitor usually provides sufficient output capacitan ce for most application s. If larger amounts of capacitance are desired for improved line support an d transient response, tantalum capacitors can be used in parallel with the ceramic. The impedance of the ceramic capacitor at the switching frequency is domin ated by the capacitance, and so the output voltage ripple is mostly inde pendent of the ESR. T he output t voltage ripple V_{RIPPLE} is calculated as:

$$V_{RIPPLE} = \frac{I_{LOAD} (V_{OUT} - V_{IN})}{V_{OUT} \times C2 \times f_{SW}}$$

Where V_{IN} is the input voltage, I_{LOAD} is the load current, C2 is the ca pacitance of the output capacitor, a nd f _{SW} is the 1.3MHz switch ing frequency.

Selecting the Inductor

The inductor r is re quired to force the output voltage higher while being driven by the lower input voltage. Choose a n inductor that does not saturate at the SW current limit. A good rule for determining the inductance is to allow the peak-to-peak ripple current to be appro ximately 30%-50% of the maximum in put current. Make sure that the peak inductor current is below 75% of the typical current limit at the duty cycle used to prevent loss of regulat ion due to the current limit variation.

Calculate the required inductance value L using the equations:

$$L = \frac{V_{IN}(V_{OUT} - V_{IN})}{V_{OUT} \times f_{SW} \times \Delta I}$$
$$I_{IN(MAX)} = \frac{V_{OUT} \times I_{LOAD(MAX)}}{V_{IN} \times \eta}$$
$$\Delta I = (30\% - 50\%)I_{IN(MAX)}$$

Where $I_{LOAD(MAX)}$ is the maximum load current, ΔI is the peak-to-peak inductor ripple current and η is efficiency. For t he MP15 40, 4. 7µH is recommended for in put vo Itages less than 3. 3V and 10µH for inputs greater than 3.3V.

Selecting the Diode

The output rectifier diode supplies current to the inductor when the internal MOSFET is off. To reduce losses due to diode forward voltage and recovery time, use a Schottky diode. Choose a diode whose maximum reverse voltage rating is greater than the maximum output voltage. It is recommended to choose the MBR0520 for most applications. This diode is used for load currents less than 500mA. If the average current is more than 500mA the Microsemi UPS5817 is a good choice.



Compensation

The MP1540 uses an amplifier to compensate the feedback loop rather than a traditional transconductance amplifier like most current mode regulators. Frequency compensation is provided by an internal resistor and capacitor along with an external resistor. The system uses two poles and one zero to stabilize the control loop. The poles are f_{P1} set by the output capacitor and load resistance, and f_{P2} set by the internal compensation capacitor, the gain of the error amplifier and the resistance seen looking out at the feedback node R_{EQ} . The zero f_{Z1} is set internally around 20KHz. These are determined by the equations:

$$f_{P1} = \frac{1}{\pi \times C2 \times R_{LOAD}}$$
$$f_{P2} = \frac{1}{2 \times \pi \times (7.9 \times 10^{-9}) \times R_{EQ}}$$
$$f_{Z1} = 20 \text{KHz}$$

Where R_{LOAD} is the load resistance and R_{EQ} is:

$$\mathsf{R}_{\mathsf{EQ}} = \mathsf{R3} + \frac{(\mathsf{R1} \times \mathsf{R2})}{(\mathsf{R1} + \mathsf{R2})}$$

Where R1, R2, and R3 are seen in Figure 2.

The DC loop gain is:

$$A_{VDC} = 500 \times \frac{V_{IN} \times R_{LOAD} \times V_{FB}}{V_{OUT}^{2}}$$

There is also a right-half-plane zero (f_{RHPZ}) that exists in all continuous mode (inductor current does not drop to zero on each cycle) step up converters. The frequency of the right half plane zero is:

$$f_{RHPZ} = \frac{V_{IN}^{2} \times R_{LOAD}}{2 \times \pi \times L \times V_{OUT}^{2}}$$

To stabilize the regula tion control loop, the crossover frequency (the frequency where the loop gain drops to 0dB or a gain of 1, indicated as f_c) should be at least one decad e below the right-half-plane zero and should b e at most 75KHz. f _{RHPZ} is a t it s lo west fr equency at maximum o utput load current (R _{LOAD} i s a t a minimum) and minimum input voltage.

For the MP1540 it is re commended that a $47k\Omega$ to $100k\Omega$ resistor be placed in series with the FB pin and the resistor divider as seen in Figure 2. For most applications this is all that is needed for stable op eration. If g reater ph ase ma rgin is needed a series resistor and capacitor can be placed in parallel with the high-side resistor R1 as seen in Figure 2. The pole and zero set by the lead-lag compensation network are:

$$f_{P3} = \frac{1}{2 \times \pi \times C3 \times \left(R4 + \frac{1}{\frac{1}{R1} + \frac{1}{R2} + \frac{1}{R3}}\right)}$$
$$f_{Z2} = \frac{1}{2 \times \pi \times C3 \times (R1 + R4)}$$

Layout Considerations

High frequ ency switching regulators require very careful layout for stable operation and low noise. All components must be placed as close to the IC as possible. Keep the path betwee n L1, D1, and C2 ex tremely short for minimal noise and r inging. C1 must be placed close to the IN pin for best decoupling. All feedback components must be kept close to the FB pin to prevent noise injection on the FB pin trace. The ground return of C1 and C2 should be tied close to the GND pin.



TYPICAL APPLICATIONS

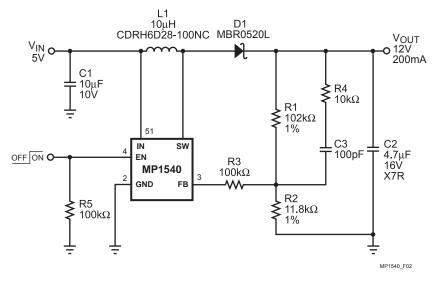


Figure 2— V_{IN} = 5V, V_{OUT} = 12V, I_{OUT} = 200mA Boost Circuit

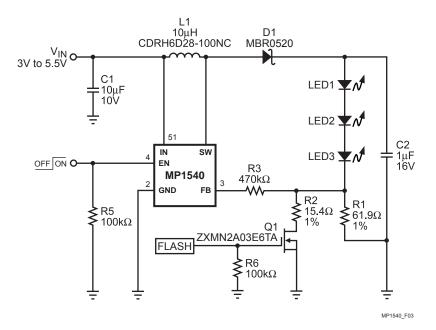
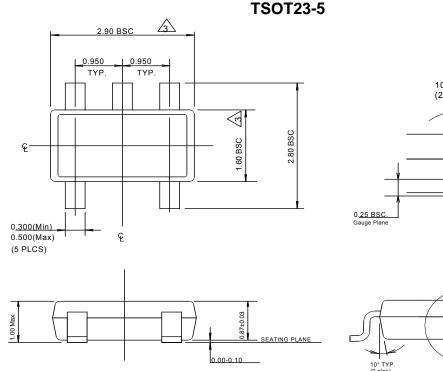
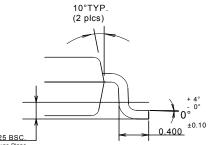


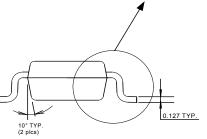
Figure 3—Typical Application Circuit for Driving Flashlight LEDs (20mA Torch Current, 100mA Flash Current)



PACKAGE INFORMATION







NOTE:

- 1. Dimensions and tolerances are as per ANSI $Y14.5M,\,1994.$
- 2. Die is facing up for mold. Die is facing down for trim/form, ie. reverse trim/form.

Dimensions are exclusive of mold flash and gate burr.

- 4. The footlength measuring is based on the gauge pl ane m ethod.
- 5. All specification comply to Jedec Spec MO193 Issue C.

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